Microsystems Engineering, College of Engineering Rochester Institute of Technology 168 Lomb Memorial Dr., Rochester, NY 14623 (585) 475-2058 bwsemc@rit.edu

SUMMARY

Bruce Smith has over 30 years of research, academic, industry, and consulting engineering experience in integrated circuit processing, microelectronics, microlithography, and imaging systems. He is a professor of Microelectronic Engineering and the Director of the Ph.D. program in Microsystems Engineering at the Rochester Institute of Technology. His industry experience includes manufacturing and R&D and he has worked with companies in the US, Europe, and Asia. Professor Smith is a Fellow of the OSA, a Fellow of SPIE, a Senior Member of IEEE, and a member of AVS, ASEE, and SID. He is the recipient of RIT's Trustees Scholarship Award, a SPIE Research Mentoring Award, RIT's Creators Award, and the Rush Henrietta Outstanding Alumni Award, among others, and has been inducted into RIT's Innovator Hall of Fame. Professor Smith has over 150 publications including technical papers, articles, textbooks, and textbook chapters. He holds 25 patents and has licensed his technology both nationally and internationally.

PROFESSIONAL EXPERIENCE

Rochester Institute of Technology, Professor, Kate Gleason College of Engineering, 1988-present

Director, Microsystems Engineering Ph.D. Program, 2008-present

Intel Professor of Research and Technology, 2000-2007

Associate Dean of Graduate Programs, Kate Gleason College of Engineering, 2001-2004

Director, Center for Nanolithography Research, 2004-present

Professor, Microelectronic Engineering Department, 1988-2008

- IMEC at University of Leuven, Belgium, Visiting Professor, 2008
- Lithographic Technology Corp / Amphibian Systems, President, 1998-present
- IMEC at University of Leuven, Belgium, Visiting Professor, 2001
- International SEMATECH, Austin Texas, Visiting Scholar, 1997
- Rutherford Appleton Laboratories, Oxford, U.K., Visiting Scientist, 1995
- Digital Equipment Corp., Hudson, Mass., Advanced Development Center, 1986-1988
- Gould AMI Semiconductor, Santa Clara, Calif., Process Development Group, 1983-1986

EDUCATION

- B.S., M.S. Rochester Institute of Technology, Photographic and Imaging Science.
- Ph.D., Rochester Institute of Technology, Imaging Science.

LITIGATION SUPPORT EXPERIENCE

Date: 2013- Ropes and Gray LLP

Case: Spansion LLC v. Macronix America Co., Ltd. et al Project: ITC patent infringement case – Testifying Expert

Field: Flash memory chip method and processes

Date: 2013 – McKenna Long & Aldridge LLP

Case: Eidos Display, LLC v. AU Optronics Corp. et al (AU, Chi Mei Innolux, Chunghwa,

Hannstar, and Hannspree)

Project: Patent Infringement (USDC, E. Texas) – Testifying Expert

Field: This film transistor (TFT) processing for LCDs

Date: 2013- Mintz, Levin, Cohn, Ferris, Glovsky, and Pepeo PC

Case: <u>Graphics Properties Holdings</u>, Inc. v. Panasonic Corp. of North America et al (Toshiba,

Barnes and Noble, Google, Hewlett-Packard, Lenova, and ZTE)

Project: Patent infringement (Delaware Federal District)

Field: Wide angle LCD display devices



Date: 2012 – Bunsow, DeMory, Smith, & Allison LLP

Case: NXP B.V. v. Research in Motion Ltd. et. al. (TriQuint, SanDisk, Hynix, and Qualcomm)

Project: Patent Infringement (USDC, FLA Middle District), IPR (USPTO) – Testifying Expert

Field: Dummy pattern fill for integrated circuit fabrication

Date: 2011 –2012 Mintz, Levin, Cohn, Ferris, Glovsky, and Pepeo PC

Case: <u>Graphics Properties Holdings</u> v. Respondents (RIM, HTC, LG, Apple, Samsung, and

Sony)

Project: ITC Patent Infringement – Testifying Expert Field: LCD stack configuration for display devices

Date: 2011 O'Melveny and Meyers

Case: Samsung Electronics Co. Ltd. v. AU Optronics Corp. et al (Acer, BenQ, and SANYO)

Project: ITC Patent infringement

Field: Flat panel display device manufacturing processes

Date: 2010-2011 McDermott Will & Emery

Case: <u>Spansion Inc.</u> v. Samsung Electronics Co

Project: ITC patent infringement case – Testifying Expert Field: Contact hole processes for flash memory chips

Date: 2011- Keker and Van Nest LLP

Case: STC UNM v. Intel Corp.

Project: Patent infringement (USDC, New Mexico) – Testifying Expert

Field: Lithography techniques and integrated circuit products

Date: 2010- Irell & Manella LLP

Case: Patent re-examination

Project: USPTO re-examination and hearing – Testifying Expert

Field: Flat panel display illumination devices

Date: 2010 Keker and Van Nest LLP

Case: STC UNM v. <u>Taiwan Semiconductor Manufacturing Co.</u>

Project: ITC patent infringement

Field: Lithography techniques and integrated circuit products

Date: 2010-2011 McDermott Will & Emery

Case Spansion LLC v. Samsung Electronics Co. (and counter-claim)

Project: Patent infringement case (USDC, E.D. Va. District) – Testifying Expert

Field: Flash memory device processes

Date: 2010-2011 Irell & Manella LLP

Case: <u>Chi Mei Innolux</u> v. Sony Corporation

Project: ITC patent infringement case Field LCD flat panel patterned electrodes

Date: 2010-2011 Ropes and Gray LLP

Case: Samsung Electronics Co. v. Spansion Japan Ltd.

Project: ITC patent infringement case

Field: Lithography and etch processing for flash memory products

Date: 2010 Sidley Austin LLP

Case: Agere Systems Inc. and LSI v. Xilinx, Inc.

Project: Patent infringement (S.D. N.Y.)
Field: Metallization of integrated circuits

Date: 2010 McDermott Will & Emery

Case: Samsung Electronics Co. v. Spansion LLC and Spansion Inc.



Project: ITC patent infringement case

Field: Lithography and etch processing for flash memory products

Date: 2010 Standley Law Group LLP

Case: American Panel v. Vertex
Project: Patent infringement arbitration
Field Flat panel display technology

Date: 2009-2011 Irell & Manella LLP

Case: Apeldyn Corp. v. Chi Mei Optoelectronics Corp. et al (AU, Samsung, Sharp, and Sony)

Project: Patent infringement (USDC, Delaware) – Testifying Expert

Field: LCD flat panel response time

Date: 2009-10 Fish and Richardson P.C.

Case: <u>Semiconductor Energy Laboratory Co. Ltd.</u> v. Eastman Kodak

Project: Patent interference case (USPTO)

Field: Organic light emitting diode (OLED) display devices

Date: 2009 Steptoe and Johnson, LLP

Case: Qimonda AG v. Seagate Technology

Project: ITC patent infringement case - Testifying Expert

Field: Polysilicon and amorphous silicon technology; silicon-oxi-nitride anti-reflection coating

deposition technology

Date: 2009 Fish and Richardson P.C.

Case: Sharp Corp. v. <u>Samsung Electronics Co. Ltd.</u>

Project: Patent infringement, (E.D. Tx.)

Field: Liquid crystal display polarizers and electro static discharge (ESD) technology

Date: 2008 Steptoe and Johnson, LLP

Case: Neumark-Rothschild v. <u>Toshiba Corp.</u>

Project: ITC patent infringement case

Field: Wide bandgap (II-VI and III-V) semiconductor materials processing for short-

wavelength LEDs and laser diodes

Date: 2006 –2012 Wolf Block Schorr and Solis-Cohen, LLP

Bernstein Litowitz Berger & Grossmann LLP

Case: Anvik Corp. v. Nikon Corp., et al (Toshiba, Samsung, LG Electronics, Sharp, LG, Chi

Mei, AU, AFPD, Panasonic, IPS, and Hitachi,

Project: Patent infringement (USDC, S. NY District) – Testifying Expert

Field: Lithography method for LCD flat panel manufacturing

Date: 2007-08 Ropes & Gray, LLP

Case: Akrion Inc., v. Solid State Equipment Corp.

Project: Patent infringement

Field: Silicon wafer cleaning and preparation

Date: 2007-08 Fish and Richardson P.C.

Case: Renesas Technology v. <u>Samsung Electronics</u>
Project: ITC patent infringement case – Testifying Expert

Field: Thin film and diffractive elements for photomask mask light blocking

Date: 2005-06 Vinson & Elkins, LLP

Case: <u>Advanced Micro Devices</u> v. Oki Electronics

Project: Patent infringement (USDC, N. CA District) – Testifying Expert

Field: Silicon wafer preparation and coating

Date: 2004-05 Irell & Manella, LLP

Case: Ultratech Stepper, Inc. v. <u>ASM Lithography, Inc.</u>



Project: Patent infringement (USDC, N. CA District) – Testifying Expert

Field: Optical microlithography scanning

Date: 1997-03 Ward Norris Heller & Reidy, LLP – Testifying Expert

Case: IBM Fishkill, NY and Essex, VT, including Union Carbide Corp., Eastman Kodak, J. T.

Baker Chemical, KTI, Shipley, Ashland Oil, E. I. DuPont de Nemours and Industri-

Chem, suppliers of solvents for the IBM cleanroom operations

Field: Multi-state litigation, allegations regarding various chemicals used in the manufacturing

of semiconductor devices

Date: 1997-03 Ward Norris Heller & Reidy, LLP – Testifying Expert

Kasowitz Benson Torres & Friedman, LLP

Steptoe & Johnson, LLP

Cases: San Jose IBM Workers Litigation v. Shipley Company

San Jose IBM Workers Litigation v. American Hoechst Corporation

San Jose IBM Workers Litigation v. Ashland Chemical Company, Union Carbide

Corporation, Fischer Scientific Company, and Eastman Kodak Company

Rubio v. IBM et al.

Field: Allegations regarding various chemicals used in an manufacturing of semiconductor

devices

SERVICE

Professional Associations

Fellow, SPIE International Society for Optical Engineering

Fellow, The Optical Society of America

Senior Member, Institute of Electrical and Electronics Engineers

Member, American Vacuum Society

Member, American Society for Engineering Education

Member, Society for Information Display

External Service

1997-2013	SPIE Optical Microlithography, Program Committee
2010-2013	EIPBN Program Committee

Visiting Scholar, International Sematech

Texas Instruments, Douglas Harvey Award

2003-2013 SPIE Zernike Award Committee

2009-2010 Councilor, Optical Society of America (OSA), Rochester Section

2008-2009 Program Chairman, International Symposium on Immersion Lithography Extensions

2004-2005 Conference Chairman, SPIE Optical Microlithography Conference

1997-2002 EIPBN Program Committee

1997-1998 SPIE/ISMA Singapore Program Committee

1995-1997 Chairman, OSA Lithography / Patterning Technical Working Group

1990-1996 Faculty Advisor, SPIE Student Chapter

Honors and Awards

Honors and Awards	
SPIE Research Mentor Award	
Visiting Professor, IMEC Micro and Nanoelectronics Research Center	
Trustees Excellence in Scholarship and Teaching Award, Rochester Institute of Technology	
Fellow, SPIE International Society for Optical Engineering	
Rush Henrietta Outstanding Alumni Award	
Million Dollar Principle Investigator Award, Rochester Institute of Technology	
Patenting Productivity Award, Rochester Institute of Technology	
Intellectual Property Productivity Award, Rochester Institute of Technology	
Visiting Professor, IMEC Micro and Nanoelectronics Research Center	
Intel Professor of Research and Technology, Intel Corp.	
RIT Creators Award, Rochester Institute of Technology	



1997

1993

Editorial Review

Editorial review of IEEE, JVAC, JM3, and SPIE, journals.

PATENTS

- 1. 7,768,648 Method for aberration evaluation in a projection system
- 2. 7,345,735 Apparatus for aberration detection and measurement
- 3. 7,233,887 Method of photomask correction and its optimization using localized frequency analysis
- 4. 7,170,588 Reduction Smith-Talbot interferometer prism for micropatterning
- 5. 7,136,143 Method for aberration detection and measurement
- 6. 7,092,073 Method of illuminating a photomask using chevron illumination
- 7. 6,934,010 Optical proximity correction method utilizing gray bars as sub-resolution assist features
- 8. 6,881,523 Optical proximity correction method utilizing ruled ladder bars as sub-resolution assist features
- 9. 6,846,595 Method of improving photomask geometry
- 10. 6,835,505 Mask for projection photolithography at or below about 160 nm and a method thereof
- 11. 6,791,667 Illumination device for projection system and method for fabricating
- 12. 6,788,388 Illumination device for projection system and method for fabricating
- 13. 6,556,361 Projection imaging system with a non-circular aperture and a method thereof
- 14. 6,541,750 Modification of a projection imaging system with a non-circular aperture and a method thereof
- 15. 6,525,806 Apparatus and method of image enhancement through spatial filtering
- 16. 6,480,263 Apparatus and method for phase shift photomasking
- 17. 6,466,304 Illumination device for projection system and method for fabricating
- 18. 6,395,433 Photomask for projection lithography at or below about 160 nm and a method thereof
- 19. 6,388,736 Imaging method using phase boundary masking with modified illumination
- 20. 6,368,755 Masks for use in optical lithography below 180 nm
- 21. 6,309,780 Attenuated phase shift mask and a method for making the mask
- 22. 5,939,227 Multi-layered attenuated phase shift mask and a method for making the mask
- 23. JP2010079303 Method of improving photomask geometry
- 24. JP2006079117 Optical proximity correction method utilizing gray bar as sub-resolution assist feature
- 25. EP1240557 Imaging method using phase boundary masking with modified illumination

SELECTED PUBLICATIONS

- 1. "Extreme ultraviolet lithography resist-based aberration metrology," Germain L. Fenger; Lei Sun; Sudharshanan Raghunathan; Obert R. Wood; Bruce W. Smith, J. Micro/Nanolith. MEMS MOEMS. 12 (4), 2013.
- 2. "The Impact of Pupil Plane Filtering on Mask Roughness Transfer," Burak Baylav, Chris Maloney, Zac Levinson, Joost Bekaert, Alessandro Vaglio Pret, and Bruce W. Smith, J. Vac. Sci. Technol. B 31, 06F801, 2013.
- 3. "Modeling the effects of pupil-manipulated spherical aberration in optical nanolithography", M. K. Sears, B.W. Smith, J. Micro/Nanolith. MEMS MOEMS. 12(1), 2013.
- 4. "Scanning interference evanescent wave lithography for sub-22-nm generations," P. Xie, B. W. Smith, J. Micro/Nanolithography, MEMS, and MOEMS. 12(1), 2013.
- 5. "Lens wavefront compensation for 3D photomask effects in subwavelength optical lithography," M.K. Sears, J. Bekaert, B.W. Smith, Applied Optics 52 (3), 314-322, 2013.
- 6. "Line edge roughness (LER) mitigation studies specific to interference-like lithography,: B Baylav, A Estroff, P Xie, BW Smith, Proc. SPIE 8683, Optical Microlithography XXVI, 86831Y, 2013
- 7. "Pupil wavefront manipulation to compensate for mask topography effects in optical nanolithography," MK Sears, BW Smith, Proc. SPIE 8683, Optical Microlithography XXVI, 86830G, 2013.
- 8. "EUVL resist-based aberration metrology," Germain L. Fenger; Sudharshanan Raghunathan; Lei Sun; Obert R. Wood; Bruce W. Smith, Proc. SPIE 8679, Extreme Ultraviolet (EUV) Lithography IV, 86790P, 2013.
- 9. "Tuning Metamaterials for Applications at DUV Wavelengths," A. Estroff, B.W. Smith, Intl. Journal of Optics, 2012.



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